

### **Additional Information**







Resources

Samples

### **Electrical Characteristics**

% of Ampere Rating	Opening Time
100%	4 Hours, Min.
200%	1 Sec. Min.; 120 Secs. Max.
300%	0.1 Sec. Min.; 3 Secs. Max.
800%	0.002 Sec. Min.; 0.05 Sec. Max.

# **Description**

The 407A Series AEC-Qualified fuse is specifically tested to cater to secondary circuit protection needs of compact auto electronics applications.

The general design ensures excellent temperature stability and performance reliability. This high I2t fuse series is designed to have ultra high inrush current withstand capability to avoid nuisance fuse open.

## **Features & Benefits**

- Operating Temperature from -55 °C to +150 °C
- 100% Lead-free, RoHS Compliant and Halogen-free
- Suitable for both leaded and lead-free reflow/wave soldering
- UL Recognized to UL/CSA/NMX 248-1 and UL/CSA/NMX 248-14
- Ultra-high I<sup>2</sup>t values
- Avoids nuisance opening due to high inrush and surge current inherent in the system
- High current ratings in small size
- AEC-Q200 Qualified

# **Applications**

- Li-ion battery
- LED lighting
- Automotive navigation system
- TFT display
- Battery Management System (BMS)
- Infotainment

## **Agency Approvals**

Agency	Agency File/Certificate Number	Ampere Range	
c <b>711</b> ° us	E10480	1 A-8 A	

### **Electrical Specifications**

Ampere Rating Amp Code (A)	Amn Code	Max. Voltage Rating	Interrupting Rating	Nominal Resistance (Ohms) <sup>2</sup>	Nominal Melting I²t (A²Sec.)³	Nominal Voltage Drop at Rated Current (V) <sup>4</sup>	Nominal Power Dissipation at Rated Current (W)	Agency Approval
	Amp code	(V)	(AC/DC) <sup>1</sup>					c <b>AL</b> °us
1.00	001.	63		0.360	0.142	0.456	0.456	X
1.25	1.25	63	50A@63VDC	0.200	0.329	0.404	0.500	x
1.50	01.5	63	50A@03VDC	0.180	0.567	0.347	0.525	x
2.00	002.	63		0.100	0.870	0.323	0.640	×
2.50	02.5	32		0.055	1.000	0.252	0.625	x
3.00	003.	32		0.040	1.300	0.187	0.570	x
3.50	03.5	32	50A@32VDC	0.030	2.260	0.153	0.525	x
4.00	004.	32	50A@32VDC	0.025	4.180	0.142	0.560	X
4.50	04.5	32		0.020	5.200	0.134	0.585	X
5.00	005.	32		0.016	7.800	0.133	0.650	x
5.50	05.5	24	50A@24VDC	0.014	8.550	0.130	0.715	x
6.00	006.	24	60A@24VDC	0.012	15.560	0.128	0.780	х
7.00	007.	24		0.010	16.230	0.110	0.770	×
8.00	008.	24		0.009	24.120	0.097	0.800	X

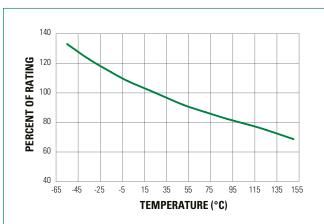
### Notes

- 1. AC Interrupting Rating tested at rated voltage with unity power factor. DC Interrupting Rating tested at rated voltage with time constant < 0.8 msec
- 2. Nominal Resistance measured with < 10% rated current 3. Nominal Melting I2t measured at 1msec, opening time.
- 4. Nominal Voltage Drop measured at rated current after temperature has stabilized.
- Devices designed to carry rated current for 4 hours minimum. It is recommended that devices be operated continuously at no more than 80% rated current. See Temperature Derating Curve for additional derating information.
- Devices designed to be mounted with marking code facing up.



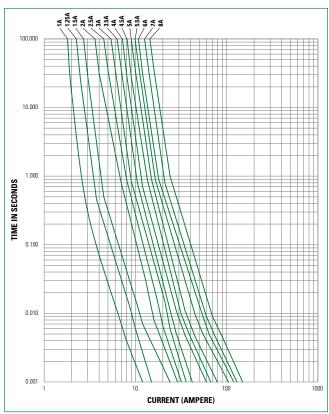
# **407A Series** AEC-Q200 Qualified > Ceramic Fuse

# **Temperature Re-rating Curve**



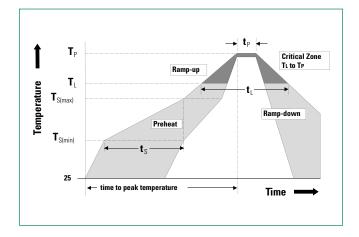
Note
Re-rating depicted in this curve is in addition to the standard re-rating of 20% for continuous operation. **Example** For continuous operation at 75 °C, the fuse should be rerated as follows:  $I = (0.80)(0.85)I_n = (0.68)I_n$ .

# **Average Time Current Curves**



# **Soldering Parameters**

Reflow Condition		Pb-free assembly		
	-Temperature Min (Ts(min))		150 °C	
Pre Heat	-Temperature Max (Ts(max))		200 °C	
	-Time (Min to Max) (	ts)	60-180 seconds	
Average Ramp-up Rate (Liquidus Temp (TL) to peak)		3 °C/second max.		
TS(max) to TL - Ramp-up Rate		5 °C/second max.		
Reflow	-Temperature (TL) (Liquidus)		217 °C	
nellow	-Temperature (tL)		60-150 seconds	
Peak Temperature (TP)		260+0/-5 °C		
Time within 5°C of actual peak Temperature (tp)		10-30 seconds		
Ramp-down Rate		6 °C/second max.		
Time 25°C to peak Temperature (TP)		8 minutes max.		
Do not exceed			260 °C	
Wave solder	Wave soldering 260 °C, 10 seconds max.		0 seconds max.	





# **407A Series** AEC-Q200 Qualified > Ceramic Fuse

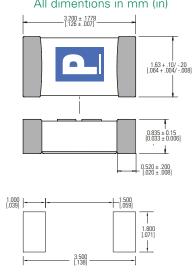
### **Product Characteristics**

Materials	Body: Advanced Ceramic Terminations: Ag / Ni / Sn (100% Lead-free) Element Cover Coating: Lead-free Glass
Moisture Sensitivity Level	IPC/JEDEC J-STD-020, Level 1
Solderability	IPC/ECA/JEDEC J-STD-002, Condition C
<b>Humidity Test</b>	MIL-STD-202, Method 103, Conditions D
Resistance to Solder Heat	MIL-STD-202, Method 210, Condition B
Moisture Resistance	MIL-STD-202, Method 106
Thermal Shock	MIL-STD-202, Method 107, Condition B
Mechanical Shock	MIL-STD-202, Method 213, Condition A
Vibration	MIL-STD-202, Method 201
Vibration, High Frequency	MIL-STD-202, Method 204, Condition D
Dissolution of Metallization	IPC/ECA/JEDEC J-STD-002, Condition D
Terminal Strength	IEC 60127-4

High Temperature Storage	MIL-STD-202, Method 108 with exemptions
Thermal Shock Test	JESD22 Method JA-104, Test Conditions B and N
Biased Humidity	MIL-STD-202, Method 103, 85 °C/85% RH with 10% operating power for 1,000 hrs
Operational Life	MIL-STD-202, Method 108, Test Condition D
Resistance to Solvents	MIL-STD-202, Method 215
Mechanical Shock	MIL-STD-202, Method 213, Test Condition C
High Frequency Vibration	MIL-STD-202, Method 204
Resistance to Soldering Heat	MIL-STD-202, Method 210, Test Condition B
Solderability	JESD22-B102E Method 1
Terminal Strength for SMD	AEC-Q200-006
Board Flex	AEC-Q200-005
Electrical Characterization	Conducted at minimum, ambient and maximum temperatures

# **Dimensions**

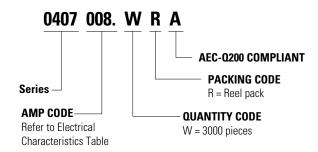




# **Part Marking System**

Amp Code	Marking Code
001.	<u>H</u>
1.25	<u>J</u>
01.5	<u>K</u>
002.	<u>N</u>
02.5	<u>o</u>
003.	<u>P</u>
03.5	<u>R</u>
004.	<u>s</u>
04.5	<u>S.</u>
005.	I
05.5	<u>U</u>
006.	<u>V</u>
007.	<u>w</u>
008.	<u>X</u>

### **Part Numbering System**



### **Packaging**

Packaging Option	Form Factor	Packaging Specification	Quantity	Quantity & Packaging Code
8mm Tape and Reel	Surface Mount	EIA-481, IEC 60286-3	3000	WR

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